EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	2	US-20070161159-$.DID.	US-PGPUB; USPAT; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2008/11/26 15:23
S7	8	US-20010015256-A1.DID. OR US-20010053559-A1.DID. OR WO-2003010825-A1.DID. OR WO-20000511181-A1.DID. OR EP-119379-$.DID. OR JP-2003203898-$.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 08:43
S8	0	WO-2003010825-A1.DID. OR WO-20000511181-A1.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 08:45
S9	2	"7452786".PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:28
S10	2	"7271076".PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:33
S11	39	("20010015256" | "20010053559" | "20020090765" | "20030022403" | "20030032210" | "20040087110" | "20040256618" | "20050037529" | "20050042798" | "20050095760" | "20050148121" | "5206749" | "5317236" | "5376561" | "5378536" | "5389438" | "5757456" | "5821138" | "5834327" | "5888858" | "5985740" | "6043800" | "6063654" | "6100562" | "6118502" | "6165824" |	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:33

		"6168829" | "6180439" | "6348368" | "6376333" | "6465287" | "6479333" | "6781152" | "6893503" | "7045438" | "7056381" | "7122445" | "7129145").PN. OR ("7271076").URPN.				
S12	8	("20010015256" | "20010053559" | "20030022403" | "20030032210" | "20040087110" | "20040256618" | "20050148121" | "7091070").PN. OR ("7452786").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:34
S13	412	KONDO-TAKAYUKI.IN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:37
S14	51591	sacrificial	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:38
S15	31	S13 and S14	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:38
S16	12	("5073230" | "5286335" | "5391257" | "5401983" | "5465009" | "5827751" | "6033995" | "6214733").PN. OR ("6858518").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:44
S17	13	("4356429" | "4539507" | "5073230" | "5286335" | "5300788" | "5391257" | "5401983" | "5465009" | "5827751" | "6033995" | "6214733" | "6291266").PN. OR ("7244662").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 10:45
S18	10	("20010015256" | "20030022403" | "20050051872" | "20050106839" | "6887650" | "7060153").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:54

S19	2	US-20050106839-A1. did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 10:59
S20	18	("20010053559" | "20030032210" | "20040087110" | "20040256618" | "20050148121" | "20050287846" | "5378536" | "5389438" | "6168829").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:08
S21	91	("20030006121" | "20040016115" | "20040026520" | "20050037529" | "20050042798" | "20050116048" | "20070063057" | "20070166954" | "20080009125" | "5206749" | "5317236" | "5376561" | "5541399" | "5757456" | "5821138" | "5834327" | "5888858" | "5985740" | "6043800" | "6063654" | "6100562" | "6118502" | "6127199" | "6165824" | "6180439" | "6348368" | "6376333" | "6465287" | "6479333" | "6521511" | "6627518" | "6700631" | "6781152" | "6814832" | "6821553" | "6825072" | "6858518" | "6893503" | "6911358" | "7045438" | "7056381" | "7091070" | "7122445" | "7129145" | "7159241" | "7166500" | "7244662" | "7271076").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:15
S22	56	S11 OR S12 OR S16 OR S17	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:44

S23	10860156	separa$6 or remov$6 or releas$6 or sacrific$6 or delaminat$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:45
S24	55	S22 AND S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:46
S25	853924	etch$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:59
S26	8878020	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 11:59
S27	1268143	(thin film transistor) or "TFT" or "IDF" or chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:00
S28	10036	S27 SAME S25 SAME S26 SAME S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S29	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S30	4085	257/347.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S31	0	257/E27.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:01
S32	6436	S27 SAME (S25 WITH S26) SAME S23	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:02

S33	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S34	421	S32 AND S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S35	53	S32 SAME S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S36	79	S28 SAME S33	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:03
S37	20	("20010015256" | "20010053559" | "20030022403" | "20030032210" | "20030071953" | "20040087110" | "20040219762" | "20040256618" | "20050070038" | "20050148121" | "20050285231" | "5328868" | "5665607" | "5757456" | "6118502" | "6127199" | "6372608" | "6645830" | "6818530" | "RE38466").PN. OR ("7482248").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:10
S38	25	("20010012667" | "20010015256" | "20010053559" | "20020000629" | "20030022403" | "20030024898" | "20030032210" | "20030071953" | "20030157783" | "20040087110" | "20040219762" | "20040256618" | "20050070038" | "20050148121" | "5273609" | "5324683" | "5757456" | "6118502" | "6127199" | "6372608" |	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:11

		"6645830" | "6787440" | "6818530" | "6982209" | "RE38466").PN. OR ("7465674").URPN.				
S39	12	("20040217431" | "20060055314" | "20060121694" | "20060244063" | "20060246633" | "20060246644" | "20060246738" | "20060270066" | "4727044" | "5757456" | "6127199" | "6975018").PN. OR ("7364954").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:11
S40	45	("20010015256" | "20010053559" | "20020030189" | "20030022403" | "20030030689" | "20030032210" | "20030169204" | "20040128246" | "20040129450" | "20040129960" | "20040132265" | "20050023525" | "20050045729" | "20050051870" | "20050070038" | "20050130389" | "20050148121" | "20050168339" | "20050192129" | "20050210302" | "20050214984" | "20050287846" | "20060068536" | "20060099738" | "20060177972" | "5166556" | "5198831" | "5403700" | "5581385" | "5757456" | "5821138" | "5834327" | "6022792" | "6118502" | "6372608" | "6377176" | "6478229" | "6509217" | "6682963" | "6781152" | "6998282" | "7045438" | "7109071" | "7122445" | "7282380").PN. OR ("7368318").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:15

S41	74	S37 or S38 or S39 or S40	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S42	16	S41 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S43	202	S29 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:19
S44	121	S30 and S28	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:20
S45	10860156	separa$6 or remov$6 or releas$6 or sacrific$6 or delaminat$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S46	853924	etch$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S47	8878020	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S48	1268143	(thin film transistor) or "TFT" or "IDF" or chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S49	10036	S48 SAME S46 SAME S47 SAME S45	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25

S50	20	("20010015256" | "20010053559" | "20030022403" | "20030032210" | "20030071953" | "20040087110" | "20040219762" | "20040256618" | "20050070038" | "20050148121" | "20050285231" | "5328868" | "5665607" | "5757456" | "6118502" | "6127199" | "6372608" | "6645830" | "6818530" | "RE38466").PN. OR ("7482248").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S51	25	("20010012667" | "20010015256" | "20010053559" | "20020000629" | "20030022403" | "20030024898" | "20030032210" | "20030071953" | "20030157783" | "20040087110" | "20040219762" | "20040256618" | "20050070038" | "20050148121" | "5273609" | "5324683" | "5757456" | "6118502" | "6127199" | "6372608" | "6645830" | "6787440" | "6818530" | "6982209" | "RE38466").PN. OR ("7465674").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S52	12	("20040217431" | "20060055314" | "20060121694" | "20060244063" | "20060246633" | "20060246644" | "20060246738" | "20060270066" | "4727044" | "5757456" | "6127199" | "6975018").PN. OR ("7364954").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25

S53	45	("20010015256" | "20010053559" | "20020030189" | "20030022403" | "20030030689" | "20030032210" | "20030169204" | "20040128246" | "20040129450" | "20040129960" | "20040132265" | "20050023525" | "20050045729" | "20050051870" | "20050070038" | "20050130389" | "20050148121" | "20050168339" | "20050192129" | "20050210302" | "20050214984" | "20050287846" | "20060068536" | "20060099738" | "20060177972" | "5166556" | "5198831" | "5403700" | "5581385" | "5757456" | "5821138" | "5834327" | "6022792" | "6118502" | "6372608" | "6377176" | "6478229" | "6509217" | "6682963" | "6781152" | "6998282" | "7045438" | "7109071" | "7122445" | "7282380"). PN. OR ("7368318"). URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 12:25
S54	74	S50 or S51 or S52 or S53	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S55	16	S54 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S56	16	S55	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25

S57	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S58	202	S57 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S59	202	S58	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S60	4085	257/347.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S61	121	S60 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S62	121	S61	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:25
S63	4	S55 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:28
S64	170	S58 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:28
S65	103	S61 NOT ("semiconductor energy laboratory")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S66	85	S65 not S64	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29

S67	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S68	526166	S67	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S69	255	S64 OR S66	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:29
S70	7	S69 AND S67	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 12:30
S71	2721344	(thin film transistor) or "TFT" or "IDF" or chip or "IC" or (integrated circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S72	526166	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S73	3277701	dice or dicing or cut or cutting or scribe or scribing	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:10
S74	118259	(anisotropic NEAR2 conductor) or (ultrasonic NEAR2 adhesive) or ((ultraviolet or "UV" or curing) NEAR2 resin)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:12
S75	8502615	droplet or sputter$4 or print$4 or plat$4 or lithograph$6 or evaporat$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S76	89	S72 SAME S74 SAME S75	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13

S77	36	S76 AND S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S78	17	S77 AND S73	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:13
S79	18	S76 SAME S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:31
S80	62	S76 NOT (S78 OR S79)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:39
S81	9	S80 AND S71	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 15:39
S82	19	("20010002874" | "20010044013" | "4483067" | "4960983" | "5048179" | "5308967" | "5399847" | "5424527" | "5598032" | "5710458" | "5837992" | "5852289" | "5856662" | "6049461" | "6160526" | "6176010" | "6392297").PN. OR ("7129145").URPN.	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 15:59
S83	40385	S71 SAME S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:30
S84	22704	S71 WITH S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:30
S85	5014	S71 NEAR S72	US-PGPUB; USPAT; USOCR	ADJ	ON	2009/01/27 16:31
S86	2687	438/149.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31

S87	4085	257/347.CCLS.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S88	6392	S86 OR S87	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S89	24	S85 AND S88	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:31
S90	2	"6927108".pn.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/27 16:49
S91	118372	(anisotropic NEAR2 conductor) or (ultrasonic NEAR2 adhesive) or ((ultraviolet or "UV" or curing) NEAR2 resin)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:24
S92	526638	antenna or antennae	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:25
S93	2722924	(thin film transistor) or "TFT" or "IDF" or chip or "IC" or (integrated circuit)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:25
S94	81	S91 SAME S92 SAME S93	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:26
S95	8019	yamazaki-shunpei.in. or dairiki-koji.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:27
S96	8881152	trench or groove or opening or hole or recess or gap	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:27

S97	10865419	separa$6 or remov$6 or releas$6 or sacrific$6 or delaminat$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:28
S98	228902	S93 SAME S96 SAME S97	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:28
S99	1150	S98 SAME S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S100	309	S95 AND S98	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S101	30	S95 AND S99	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S102	854518	etch$6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:29
S103	20452	S93 SAME S96 SAME S97 same S102	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S104	20452	S103 same S102	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S105	184	S95 and S103	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30
S106	101	S103 same S92	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	ADJ	ON	2009/01/30 08:30

| S107 | 24 | S95 and S106 | US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB | ADJ | ON | 2009/01/30 08:31 |

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